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NCE75TD120VTP

1200V, 75A, Trench FS II Fast IGBT

General Description:

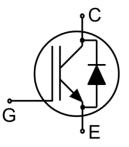
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 1200V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology Offering
- Very low V_{CE(sat)}
- High speed switching
- Positive temperature coefficient in V_{CE(sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- PV power
- Three-level Solar String Inverter



Schematic diagram

Package Marking and Ordering Information

| Device | Device Package | Device Marking | | |
|---------------|----------------|----------------|--|--|
| NCE75TD120VTP | TO-247P | NCE75TD120VTP | | |



TO-247P

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

| Symbol | Parameter | Value | Units |
|----------------------------------|--|-------------|-------|
| Vces | Collector-Emitter Voltage | 1200 | V |
| V_{GES} | Gate- Emitter Voltage | ±30 | V |
| 1- | Collector Current | 150 | А |
| Ic | Collector Current @T _C = 100 °C | 75 | А |
| I _{Cpuls} | Pulsed Collector Current, tp limited by T _{jmax} | 225 | А |
| - | turn off safe operating area, V _{CE} =1200V, Tj=150°C | 225 | Α |
| l _F | Diode Continuous Forward Current @T _C = 100 °C | 75 | Α |
| I _{FM} | Diode Maximum Forward Current | 225 | Α |
| D- | Power Dissipation @ T _C = 25°C | 833 | W |
| P _D | Power Dissipation @T _C = 100 °C | 417 | W |
| T _J ,T _{stg} | Operating Junction and Storage Temperature Range | -55 to +175 | °C |
| TL | Maximum Temperature for Soldering | 260 | °C |

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Thermal Characteristic

| Symbol | Parameter | Value | Units |
|------------------|--|-------|-------|
| Rejc | Thermal Resistance, Junction to case for IGBT | 0.18 | °C/W |
| RθJC | Thermal Resistance, Junction to case for Diode | 0.4 | °C/W |
| R _{θJA} | Thermal Resistance, Junction to Ambient | 40 | °C/W |

Electrical Characteristics (Tc=25°C unless otherwise noted)

| 0 | Parameter | Conditions | | Value | | | |
|----------------------|--------------------------------------|---|--|-------|------|------|-------|
| Symbol | Parameter | | | Min. | Тур. | Max. | Units |
| Static Chara | cteristics | • | | • | | | |
| V _{(BR)CES} | Collector-Emitter Breakdown Voltage | V _{GE} =0V | ,I _{CE} =1mA | 1200 | | | V |
| Ices | Collector-Emitter Leakage Current | V _{GE} =0V, | / _{CE} =1200V | | | 5 | uA |
| I _{GES(F)} | Gate to Emitter Forward Leakage | V _{GE} =+30 | V,V _{CE} =0V | | | 200 | nA |
| I _{GES(R)} | Gate to Emitter Reverse Leakage | V _{GE} =-30 | V _{GE} =-30V,V _{CE} =0V | | | 200 | nA |
| | O-Ht Facition Octobrilla Vallana | Ic=75A | Tj=25°C | | 1.85 | 2.05 | V |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | V _{GE} =15V | Tj=150°C | | 2.05 | | V |
| $V_{GE(th)}$ | Gate Threshold Voltage | Ic=1mA,VcE=VgE | | 4.5 | | 6.5 | V |
| Dynamic Ch | aracteristics | | | | | | |
| Cies | Input Capacitance | V _{CE} =30V,V _{GE} =0V, f=1MHz | | | 9747 | | pF |
| Coes | Output Capacitance | | | | 327 | | |
| Cres | Reverse Transfer Capacitance | | | | 271 | | |
| Qg | Total Gate Charge | Vcc=960V, Ic=75A, V _{GE} =15V | | | 572 | | nC |
| Qge | Gate to Emitter Charge | | | | 69 | | |
| Q _{gc} | Gate to Collector Charge | | | | 368 | | |
| Switching Cl | haracteristics | | | | | | |
| t _{d(ON)} | Turn-on Delay Time | | | | 19 | | |
| t r | Rise Time | | V _{CE} =600V,I _C =75A, | | 17 | | ns |
| t _{d(OFF)} | Turn-Off Delay Time | V _{CE} =600 | | | 170 | | |
| t _f | Fall Time | $V_{GE}=0/15V$, $R_g=8\Omega$ | | | 18 | | |
| Eon | Turn-On Switching Loss | Inducti | Inductive Load | | 5.6 | | |
| E _{off} | Turn-Off Switching Loss | | | | 2.7 | | mJ |
| Ets | Total Switching Loss | | | | 8.3 | | |

Electrical Characteristics of the Diode (T_C= 25°C unless otherwise specified)

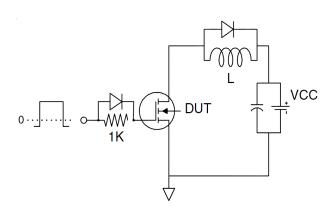
| Symbol | Parameter | Conditions | Rating | | | Heito |
|---|-------------------------------------|----------------------------|--------|------|------|-------|
| | | | Min. | Тур. | Max. | Units |
| V _{FM} | Diode Forward Voltage | I _F =75A | | 2.2 | 3.0 | V |
| Trr | Reverse Recovery Time | 1 27.54 | | 180 | | ns |
| I _{RRM} | Diode Peak Reverse Recovery Current | I⊧=37.5A, di/dt=800A/us | | 29 | | А |
| Q _{rr} | Reverse Recovery Charge | ui/ul=000A/uS | | 4.3 | | uC |
| Pulse width t _{tp} ≤380μs,δ≤2% | | | | | | |



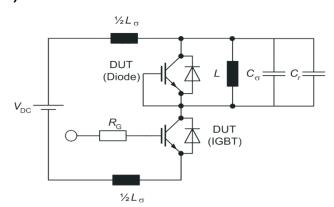
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Test Circuit

1) Gate Charge Test Circuit

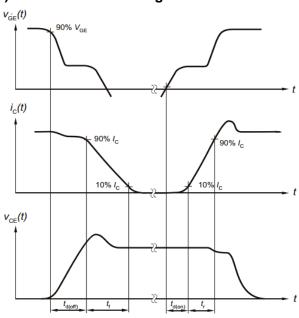


2) Switch Time Test Circuit

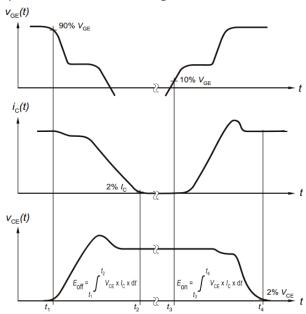


Switching characteristics

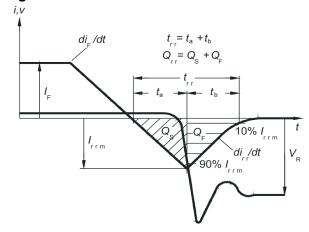
1) Definition of switching times



2) Definition of switching losses



3) Definition of diode switching characteristics





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Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

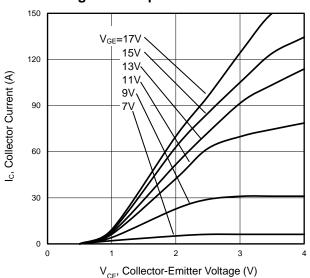


Figure 3 V_{CE(sat)} vs. Case Temperature

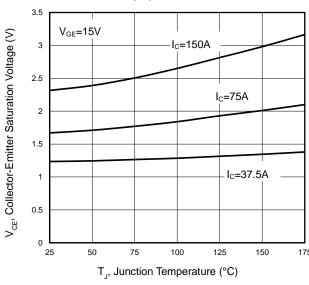


Figure 5 Capacitance Characteristics

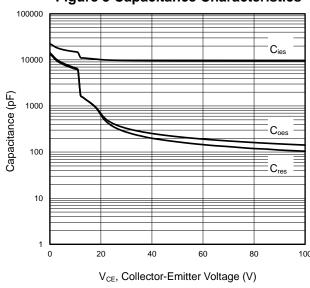


Figure 2 Transfer Characteristics

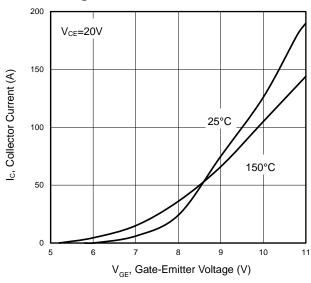


Figure 4 Saturation Voltage vs. V_{GE}

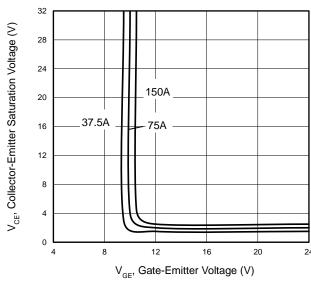
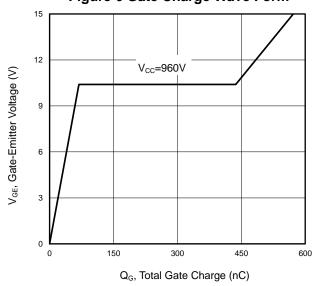


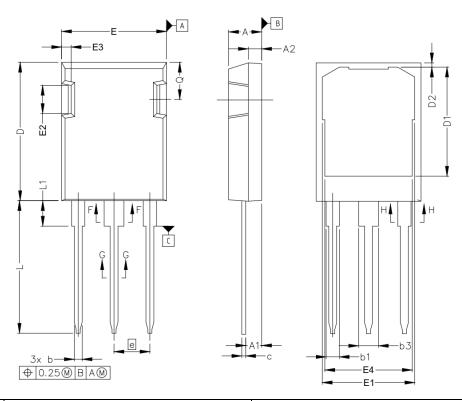
Figure 6 Gate Charge Wave Form



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TO-247P Package Information



| Cumbal | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|-------|----------------------|------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| Α | 4.83 | 5.21 | 0.19 | 0.21 | |
| A1 | 2.29 | 2.54 | 0.09 | 0.10 | |
| A2 | 1.91 | 2.16 | 0.08 | 0.09 | |
| b | 1.07 | 1.33 | 0.04 | 0.05 | |
| b1 | 1.91 | 2.41 | 0.08 | 0.09 | |
| b3 | 2.87 | 3.38 | 0.11 | 0.13 | |
| С | 0.55 | 0.68 | 0.02 | 0.03 | |
| D | 20.80 | 21.10 | 0.82 | 0.83 | |
| D1 | 16.25 | 17.65 | 0.64 | 0.69 | |
| D2 | 0.50 | 0.80 | 0.02 | 0.03 | |
| E | 15.75 | 16.13 | 0.62 | 0.64 | |
| E1 | 13.10 | 14.15 | 0.52 | 0.56 | |
| E2 | 3.68 | 5.10 | 0.14 | 0.20 | |
| E3 | 1.00 | 1.90 | 0.04 | 0.07 | |
| E4 | 12.38 | 13.43 | 0.49 | 0.53 | |
| е | 5.44BSC | | 0.2 | 21 | |
| N | 3.00 | | 0.12 | | |
| L | 19.81 | 20.32 | 0.78 | 0.80 | |
| L1 | 3.70 | 4.00 | 0.15 | 0.16 | |
| Q | 5.49 | 6.00 | 0.22 | 0.24 | |



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